



ZXMN6A09K

#### **60V N-CHANNEL ENHANCEMENT MODE MOSFET**

### **Product Summary**

BV <sub>DSS</sub>	Max R <sub>DS(on)</sub>	Max I <sub>D</sub> T <sub>A</sub> = +25°C (Note 4)
60V	40mΩ @ V <sub>GS</sub> = 10V	7.7A
60 V	$60 \text{m}\Omega$ @ $V_{GS} = 4.5 \text{V}$	6.3A

# **Description and Applications**

This MOSFET is designed to minimize the on-state resistance  $(R_{DS(on)})$  and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- DC-DC Converters
- · Power Management Functions
- · Disconnect Switches
- Motor Control

### **Features and Benefits**

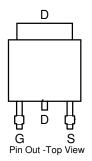
- Low On-Resistance
- Fast Switching Speed
- Low Gate Drive
- Lead-Free Finish; RoHS Compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2 & 3)
- Qualified to AEC-Q101 Standards for High Reliability

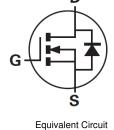
#### **Mechanical Data**

- Case: TO252 (DPAK)
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish. Solderable per MIL-STD-202, Method 208 (63)
- Weight: 0.33 grams (Approximate)



Top View





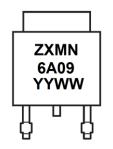
**Ordering Information** (Note 4)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXMN6A09KTC	ZXMN6A09	13	16	2,500

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



ZXMN6A09 = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 10 = 2010) WW = Week (01 - 53)



# **Maximum Ratings** (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			$V_{\mathrm{DSS}}$	60	V
Gate-Source Voltage			V <sub>GS</sub>	±20	V
		(Note 6)		11.8	
Continuous Drain Current	V <sub>GS</sub> = 10V	$T_A = +70^{\circ}C \text{ (Note 6)}$	I <sub>D</sub>	9.6	Α
		(Note 5)		7.7	
Pulsed Drain Current (Note 7)		I <sub>DM</sub>	43	Α	
Continuous Source Current (Body Diode) (Note 6)		Is	10.8	Α	
Pulsed Source Current (Body Diode) (Note 7)		I <sub>SM</sub>	43	A	

# Thermal Characteristics (@TA = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
	(Note 5)		4.3 34.4		
Power Dissipation Linear Derating Factor	(Note 6)	$P_{D}$	10.1 80.8	W mW/°C	
	(Note 8)		2.15 17.2		
	(Note 5)		29		
Thermal Resistance, Junction to Ambient	(Note 6)	$R_{AJA}$	12.3	2014	
	(Note 8)	Ť	58.1	°C/W	
Thermal Resistance, Junction to Lead	(Note 9)	$R_{ heta JL}$	1.04		
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C	

Notes:

<sup>5.</sup> For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

<sup>6.</sup> For a device surface mounted on FR4 PCB measured at  $t \le 10$  sec.

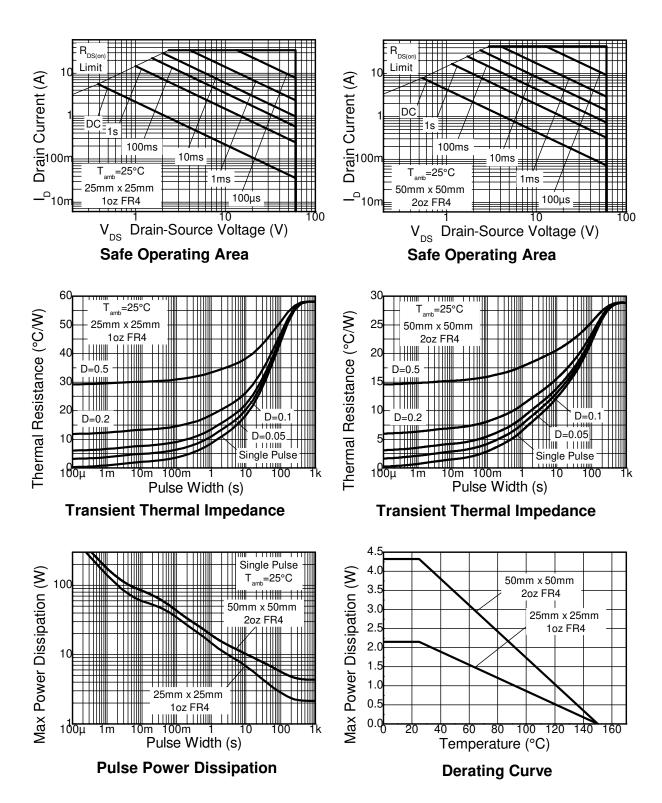
<sup>7.</sup> Repetitive rating 50mm x 50mm x 1.6mm FR4 PCB, D = 0.02 and pulse width 300 µs. The pulse current is limited by the maximum junction temperature.

<sup>8.</sup> For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

Thermal resistance from junction to solder-point (at the end of the drain lead).



## **Thermal Characteristics**





## Electrical Characteristics (@T<sub>A</sub> = +25°C unless otherwise specified.)

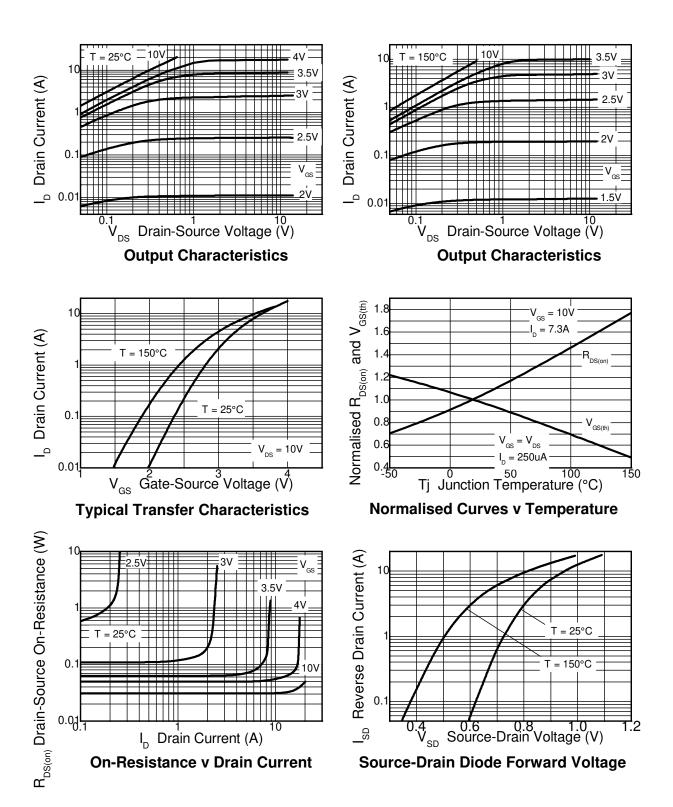
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	_	_	V	$I_D = 250 \mu A, V_{GS} = 0 V$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 60V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS							
Gate Threshold Voltage	$V_{GS(th)}$	1.0	_	3.0	V	$I_D = 250\mu A$ , $V_{DS} = V_{GS}$	
Static Drain Source On Decistones (Note 10)				40	mΩ	$V_{GS} = 10V, I_D = 7.3A$	
Static Drain-Source On-Resistance (Note 10)	R <sub>DS (ON)</sub>	_		60	11177	$V_{GS} = 4.5V, I_D = 5.6A$	
Forward Transconductance (Notes 10 & 11)	g <sub>fs</sub>	_	15	_	S	$V_{DS} = 15V, I_D = 7.3A$	
Diode Forward Voltage (Note 10)	$V_{SD}$	_	0.85	0.95	V	$I_S = 6.6A$ , $V_{GS} = 0V$ , $T_J = +25$ °C	
Reverse Recovery Time (Note 11)	t <sub>rr</sub>		25.6	_	ns	$I_S = 3A$ , di/dt = 100A/ $\mu$ s	
Reverse Recovery Charge (Note 11)	$Q_{rr}$	_	26.0	_	nC	$T_J = +25^{\circ}C$	
DYNAMIC CHARACTERISTICS (Note 11)							
Input Capacitance	Ciss	_	1426	_	pF	V 00V V 0V	
Output Capacitance	Coss	_	134		рF	$V_{DS} = 30V, V_{GS} = 0V$ -f = 1MHz	
Reverse Transfer Capacitance	Crss	_	64	_	pF	T = TIVITIZ	
Total Gate Charge (Note 12)	$Q_g$	_	15	_	nC	$V_{GS} = 4.5V, V_{DS} = 30V, I_D = 5.6A$	
Total Gate Charge (Note 12)	Qg	_	29	_	nC	V 40V V 00V	
Gate-Source Charge (Note 12)	Qgs		7.0	_	nC	$V_{GS} = 10V, V_{DS} = 30V$	
Gate-Drain Charge (Note 12)	$Q_{gd}$	_	4.7	_	nC	$I_D = 7.3A$	
Turn-On Delay Time (Note 12)	t <sub>D(on)</sub>	_	4.8	_	ns		
Turn-On Rise Time (Note 12)	t <sub>r</sub>	_	4.6	_	ns	$V_{DD}=30V,\ V_{GS}=10V$ $I_D=1A,\ R_G\cong 6.0\Omega$	
Turn-Off Delay Time (Note 12)	t <sub>D(off)</sub>	_	32.5	_	ns		
Turn-Off Fall Time (Note 12)	t <sub>f</sub>	_	14.5	_	ns		

Notes:

<sup>10.</sup> Measured under pulsed conditions. Pulse width ≤ 300µs; duty cycle ≤ 2%.
11. For design aid only, not subject to production testing.
12. Switching characteristics are independent of operating junction temperatures.

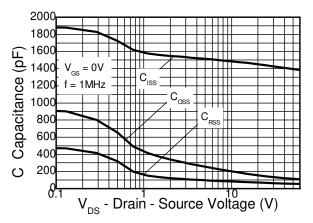


## **Typical Characteristics**

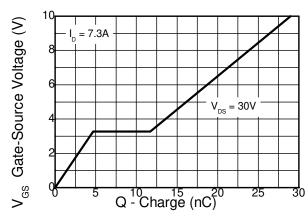




### **Typical Characteristics** (cont.)

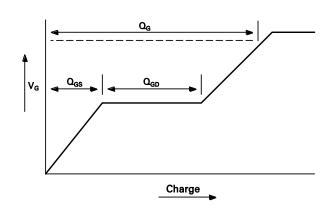


Capacitance v Drain-Source Voltage

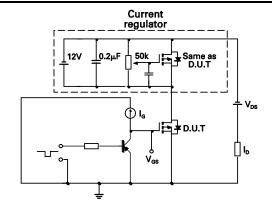


Gate-Source Voltage v Gate Charge

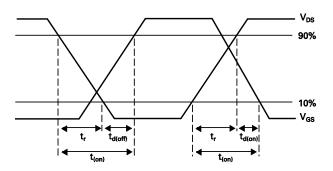
#### **Test Circuits**



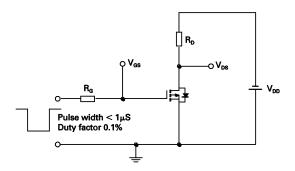
**Basic gate charge waveform** 



Gate charge test circuit



**Switching time waveforms** 

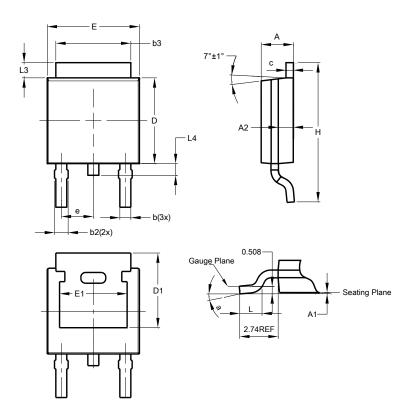


Switching time test circuit



# **Package Outline Dimensions**

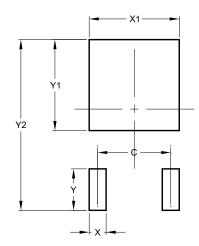
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



TO252 (DPAK)					
Dim	Min	Max	Тур		
Α	2.19	2.39	2.29		
<b>A</b> 1	0.00	0.13	0.08		
<b>A2</b>	0.97	1.17	1.07		
b	0.64	0.88	0.783		
b2	0.76	1.14	0.95		
b3	5.21	5.46	5.33		
С	0.45	0.58	0.531		
D	6.00	6.20	6.10		
D1	5.21	-	-		
е	-	-	2.286		
Е	6.45	6.70	6.58		
E1	4.32	-	-		
Н	9.40	10.41	9.91		
L	1.40	1.78	1.59		
L3	0.88	1.27	1.08		
L4	0.64	1.02	0.83		
а	0°	10°	-		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
С	4.572		
Х	1.060		
X1	5.632		
Υ	2.600		
Y1	5.700		
Y2	10.700		



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